

SURFBOARDS[®]

THE BREADBOARDING MEDIUM FOR **SURFACE MOUNT**™

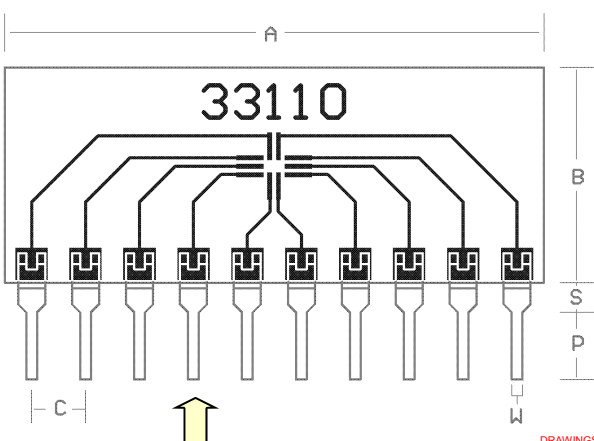


33000 SERIES APPLICATION SPECIFIC ADAPTERS

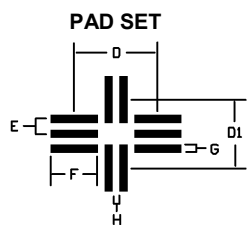
IDS33110
REV A-10-2011

MODEL **33110**

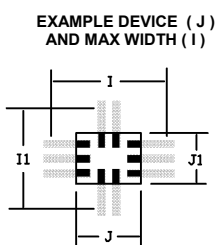
10 LEAD .4 mm PITCH
4 SIDED DEVICES



**SINGLE-IN-LINE (SIP) PINS
ON .100 in. CENTERS**



4 SIDED LEAD
FORMAT.
PIN 1 LOCATION
VARIABLE BASED
ON DEVICE
SELECTED.
SEE DEVICE
DATA SHEET.



MOUNTING PADS ARE OVERSIZED IN LENGTH TO
ACCEPT A WIDER RANGE OF DEVICE WIDTHS AND
TOLERANCES AND TO PERMIT HAND SOLDERING.
[SEE WEBSITE FOR SOLDERING SUGGESTIONS](#)

BOARD SPECIFICATIONS

BOARD MATERIAL: .8mm, +.13mm .031in+-.005 in.
Thick G-10 FR-4 Glass Epoxy or equivalent.

CIRCUITS: 1 oz. Copper with RoHS compliant Lead Free
solder coating. Pattern Position on board +-.5mm .020in.



ACCEPTS

ANALOG

FAIRCHILD

ON SEMI

TEXAS INST.

PARTIAL LISTING

LFCSP_UQ 1.3x1.6MM (CP-10-10)

10LD UMLP, QUAD 1.4x1.8MM

UQFN10 1.4x1.8,0.4P

WQFN10 1.4x1.8,0.4P

RSW (PUQFN-N10)

ALWAYS CONSULT DEVICE DATA SHEET TO INSURE PROPER FIT

Feature Pins on .1 in. Centers designed for use with Solderless
breadboards, Conventional Breadboards, and Sockets with
standard .1 in. centers.

Use For Prototyping, Device Test or Evaluation and SMD to
Through Hole Conversion.

FIG.	MM	IN.	NOTE:
A	25.4	1.0	BOARD WIDTH +-.5mm .020in.
B	10.16	.400	BOARD HEIGHT +-.5mm .020in.
C	2.54	.100	SIP PIN SPACE +-.20mm .008in.
D	2.3	.090	PAD CENTERLINE
D1	1.88	.074	PAD CENTERLINE OTHER AXIS
E	.4	.016	DEVICE LEAD PITCH
F	1.3	.051	PAD LENGTH
G	.225	.009	PAD WIDTH
H	.175	.007	GAP
I	3.15	.124	MAX LEAD WIDTH
I1	2.75	.108	MAX LEAD WIDTH OTHER AXIS
J	1.8	.070	TYPICAL LEAD WIDTH
J1	1.4	.055	TYPICAL LEAD WIDTH OTHER AXIS
P	3.3	.130	LENGTH FROM SHOULDER +-.5mm .020in.
S	1.57	.062	PIN SHOULDER HEIGHT
W	.5	.020	PIN WIDTH

TOLERANCES: If not noted are +-.20%. Nominal values are given. Controlling unit is Millimeters.
Values rounded to nearest decimal. Slight Variations due to manufacturing process can occur.

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